



GROUP 1700

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1712
PATENT
0599-0207P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: Yasushi SAWAMURA et al. Conf.: 7250
Appl. No.: 09/940,513 Group: 1712
Filed: August 29, 2001 Examiner: Keehson CHANG
For: ADHESIVE SHEET FOR SEMICONDUCTOR
CONNECTING SUBSTRATE, ADHESIVE-BACKED
TAPE FOR TAB, ADHESIVE-BACKED TAPE FOR
WIRE BONDING CONNECTION, SEMICONDUCTOR
CONNECTING SUBSTRATE, AND SEMICONDUCTOR
DEVICE

LETTER SUBMITTING FORMAL DRAWINGS

Assistant Commissioner for Patents
Washington, DC 20231

April 15, 2003

Sir:

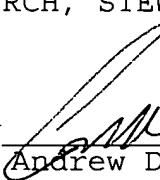
Attached hereto is/are thirteen (13) sheet(s) of formal drawings which comply with the provisions of 37 C.F.R. § 1.84. The drawings should be made a part of the record of the above-identified application.

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. §§1.16 or 1.17; particularly, extension of time fees.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP

By


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ADM/csm
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Attachments